Declaration, Power of Attorney and Petition

Page 1 of 3

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

TEMPERATURE MEASURING METHOD AND PLASMA PROCESSING APPARATUS

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the specification o	of which										•
х	is attached he	ereto.									
	was filed on			as							
	Application S	Serial No.									
	and amended	on				•					
	was filed as l	PCT internati	onal applica	tion							
	Number _										
	on		· · · · · · · · · · · · · · · · · · ·			, ,					
	and was ame	nded under P	CT Article 1	19							
	on		(if a	applicabl	le).						
We (I) hereby including the clair						nts of the abov	ve-iden	tifie	d spec	cifica	tion,
We (I) acknown as defined in Section						rial to the pate	ntabilit	ty of	this a	pplic	ation
We (I) herel application(s) for at least one count any foreign applie before that of the	patent or inverge than cation for patent	entor's certifi the United S tent or inven	cate, or § 36 tates, listed tor's certific	65(a) of below a cate, or	any PCT II nd have als PCT Interr	so identified be ational applic	plication elow, b	on w oy cl	hich d heckin	esign g the	ated box,
Application 1	No.	Co	untry		Day/M	onth/Year			Prio Clai		
P2002-3513	314	Ja	pan		03/Dece	mber/2002	_	x	Yes		No
							_		Yes		No
							_		Yes		No
		·							Yes		No
											

We (I) hereby claim the benefit under Titl application(s) listed below.	e 35, United States Co	de, § 119(e) of any United States provisional					
(Application Number)		(Filing Date)					
(Application Number)		(Filing Date)					
We (I) hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or under § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.							
Application Serial No.	Filing Date	Status (pending, patented, abandoned)					
And we (I) hereby appoint the following re	egistered practitioner(s)	:					
	22850						
as our (my) attorneys, with full powers of substi business in the Patent Office connected therew application be sent to							
	22850						
We (I) declare that all statements made here on information and belief are believed to be to that willful false statements and the like so made of Title 18 of the United States Code and the application or any patent issuing thereon.	ue; and further that the e are punishable by fine	or imprisonment, or both, under Section 1001					
Toshihiro HAYAMI NAME OF FIRST SOLE INVENTOR	Residen	ce: Nirasaki-shi, Yamanashi-ken, Japan					
P 1:15.7/ 2000)	-						
Joshihiro Hayami	Citizen e	of: Japan					
Signature of Inventor		Address: c/o TOKYO ELECTRON AT					
	_	ED, 2381-1, Kitagejo, Fujii-cho,					
November 27, 2003		i-shi, Yamanashi 407-8511 Japan					
Date							

Shosuke ENDOH	Residence: Nirasaki-shi, Yamanashi-ken, Japan
NAME OF SECOND JOINT INVENTOR	
Showke Endoh	Citizen of: Japan
Signature of Inventor	Mailing Address: c/o TOKYO ELECTRON AT
	LIMITED, 2381-1, Kitagejo, Fujii-cho,
November 27, 2003	Nirasaki-shi, Yamanashi 407-8511 Japan
Date	•
NAME OF THIRD JOINT INVENTOR	Residence:
NAME OF THIRD JOINT INVENTOR	
Signature of Inventor	Citizen of:
Signature of Inventor	Mailing Address:
Date	
	Residence
NAME OF FOURTH JOINT INVENTOR	Residence:
	Citizen of:
Signature of Inventor	Mailing Address:
Date	
NAME OF FIFTH JOINT INVENTOR	Residence:
NAME OF FIFTH JOINT INVENTOR	
Signature of Inventor	Citizen of:
	Mailing Address:
Date	